

B20 EMI Shielding Film

◆ Technical Data

Features

Excellent electromagnetic shielding performance, under the condition of dB>50 1GHz;

Good punching forming and transfer membrane hot-press peeling away;

Suitable for lead-free reflow soldering process;

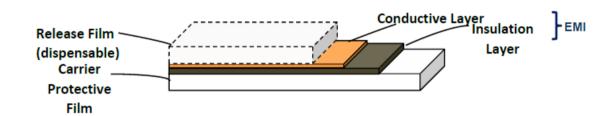
Improve OSP resistance;

Good insulation propeties $> 20*10M\Omega$;

Application

Consumer electronica, LCD modules backlight with FPC electromagnetic shielding;

Construction



♦ Types

Туре	After Press (um)	Carrier Protective Film (um)	Width (mm)
B20	15	50	250

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Characteristics		Unit	Value	Method
Peel strength (90°)	А	N/cm	≥5	IPC-TM-650 2.4.9
Release force on the side of release film		g/25mm	≪40	QS method
Soldering(288°C/10sec)			Pass	IPC-TM-650 2.4.13
Electrical performance	surface resistance	ΜΩ	>10	QS method
	Resistance (φ1mm)	Ω	≤1.0	QS method
IPC sliding test (R=0.75)	60rpm, stroke50mm	times	≥100,000	QS method
Cross-cut test	Α	Tape peeling	No delamination	QS method
	3% HCL	Tape peeling	No delamination	QS method
	5% NaOH	Tape peeling	No delamination	QS method
Shelf life	0℃-10℃	Mouths	3	QS method

♦ Storage conditions

- Keep packing condition and avoid direct sunlight
- •Stored at dry room and use a plate to put on horizomtally if need to long-term keeping

♦ Notes

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